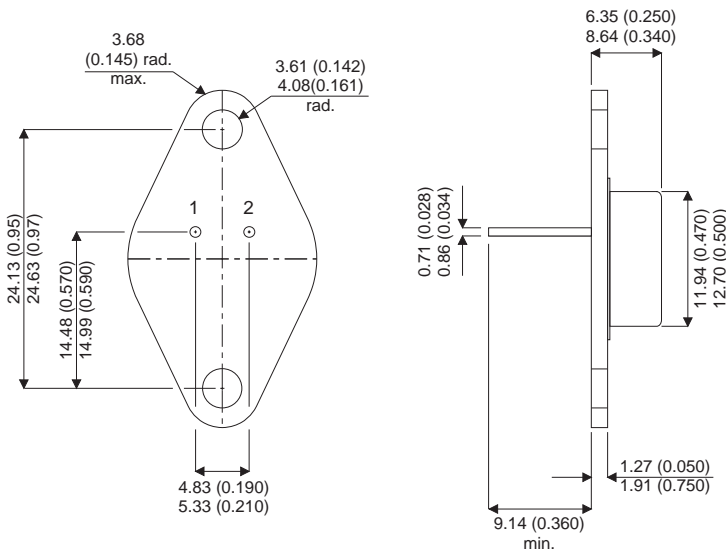


**MECHANICAL DATA**

Dimensions in mm (inches)



**N-CHANNEL  
POWER MOSFET  
FOR HI-REL  
APPLICATIONS**

**V<sub>DSS</sub>            200V**  
**I<sub>D(cont)</sub>        13A**  
**R<sub>DS(on)</sub>        0.18Ω**

**FEATURES**

- HERMETICALLY SEALED TO-66 METAL PACKAGE
- SIMPLE DRIVE REQUIREMENTS
- SCREENING OPTIONS AVAILABLE

**TO-66 METAL PACKAGE (TO213AA)**

**Underside View**

Pin 1 = Gate      Pin 2 = Source      Case = Drain

**ABSOLUTE MAXIMUM RATINGS** (T<sub>case</sub> = 25°C unless otherwise stated)

V <sub>GS</sub>	Gate – Source Voltage	±20V
I <sub>D</sub>	Continuous Drain Current @ T <sub>case</sub> = 25°C	13A
I <sub>D</sub>	Continuous Drain Current @ T <sub>case</sub> = 100°C	8A
I <sub>DM</sub>	Pulsed Drain Current	50A
P <sub>D</sub>	Power Dissipation @ T <sub>case</sub> = 25°C	70W
	Linear Derating Factor	0.56W/°C
T <sub>J</sub> , T <sub>stg</sub>	Operating and Storage Temperature Range	-55 to 150°C
R <sub>θJC</sub>	Thermal Resistance Junction to Case	1.8°C/W max.
R <sub>θJA</sub>	Thermal Resistance Junction to Ambient	50°C/W max.

Semelab Plc reserves the right to change test conditions, parameter limits and package dimensions without notice. Information furnished by Semelab is believed to be both accurate and reliable at the time of going to press. However Semelab assumes no responsibility for any errors or omissions discovered in its use. Semelab encourages customers to verify that datasheets are current before placing orders.

**ELECTRICAL CHARACTERISTICS** ( $T_C = 25^\circ\text{C}$  unless otherwise stated)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit	
<b>STATIC ELECTRICAL RATINGS</b>						
$BV_{DSS}$	Drain – Source Breakdown Voltage	$V_{GS} = 0$	$I_D = 250\mu\text{A}$	200	V	
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Temperature Coefficient of Breakdown Voltage	Reference to $25^\circ\text{C}$ $I_D = 1\text{mA}$		1.42	$\text{V}/^\circ\text{C}$	
$R_{DS(on)}$	Static Drain – Source On–State Resistance	$V_{GS} = 10\text{V}$	$I_D = 7\text{A}^*$	0.14	0.18	$\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$	$I_D = 250\mu\text{A}$	2	4	V
$g_{fs}$	Forward Transconductance	$V_{DS} \geq I_D \times R_{DS(on)}$ $I_D = 7\text{A}^*$		6	9	$\text{S}(\bar{v})$
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{GS} = 0$	$V_{DS} = 0.8BV_{DSS}$ $T_J = 125^\circ\text{C}$		250 1000	$\mu\text{A}$
$I_{GSS}$	Forward Gate – Source Leakage	$V_{GS} = 20\text{V}$			100	nA
$I_{GSS}$	Reverse Gate – Source Leakage	$V_{GS} = -20\text{V}$			-100	
<b>DYNAMIC CHARACTERISTICS</b>						
$C_{iss}$	Input Capacitance	$V_{GS} = 0$		1275		pF
$C_{oss}$	Output Capacitance	$V_{DS} = 25\text{V}$		500		
$C_{rss}$	Reverse Transfer Capacitance	$f = 1\text{MHz}$		160		
$Q_g$	Total Gate Charge	$V_{GS} = 10\text{V}$ $I_D = 16\text{A}$		43	60	nC
$Q_{gs}$	Gate – Source Charge	$V_{DS} = 0.8BV_{DSS}$		16		
$Q_{gd}$	Gate – Drain (“Miller”) Charge			27		
$t_{d(on)}$	Turn–On Delay Time	$V_{DD} = 75\text{V}$		16	30	ns
$t_r$	Rise Time	$I_D = 7\text{A}$		27	60	
$t_{d(off)}$	Turn–Off Delay Time	$Z_0 = 4.7\Omega$		40	80	
$t_f$	Fall Time			31	60	
<b>SOURCE – DRAIN DIODE CHARACTERISTICS</b>						
$I_S$	Continuous Source Current				13	A
$I_{SM}$	Pulse Source Current				50	
$V_{SD}$	Diode Forward Voltage	$I_S = 13\text{A}$	$T_J = 25^\circ\text{C}$		2	V
$t_{rr}$	Reverse Recovery Time	$I_F = 13\text{A}$	$T_J = 25^\circ\text{C}$		650	ns
$Q_{rr}$	Reverse Recovery Charge	$d_i / d_t \leq 100\text{A}/\mu\text{s}$ $V_{DD} \leq 50\text{V}$			4.1	$\mu\text{C}$
<b>PACKAGE CHARACTERISTICS</b>						
$L_D$	Internal Drain Inductance	(from 6mm down drain lead pad to centre of die)		5.0		nH
$L_S$	Internal Source Inductance	(from 6mm down source lead to centre of source bond pad)		12.5		

\* Pulse width  $\leq 300\mu\text{s}$ ; Duty Cycle  $\leq 2\%$

Semelab Plc reserves the right to change test conditions, parameter limits and package dimensions without notice. Information furnished by Semelab is believed to be both accurate and reliable at the time of going to press. However Semelab assumes no responsibility for any errors or omissions discovered in its use. Semelab encourages customers to verify that datasheets are current before placing orders.